



The GigaTracKer of the NA62 experiment at CERN

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on behalf of GTK group



CERN, UCL Louvain, Università/INFN Ferrara, Università/INFN Torino

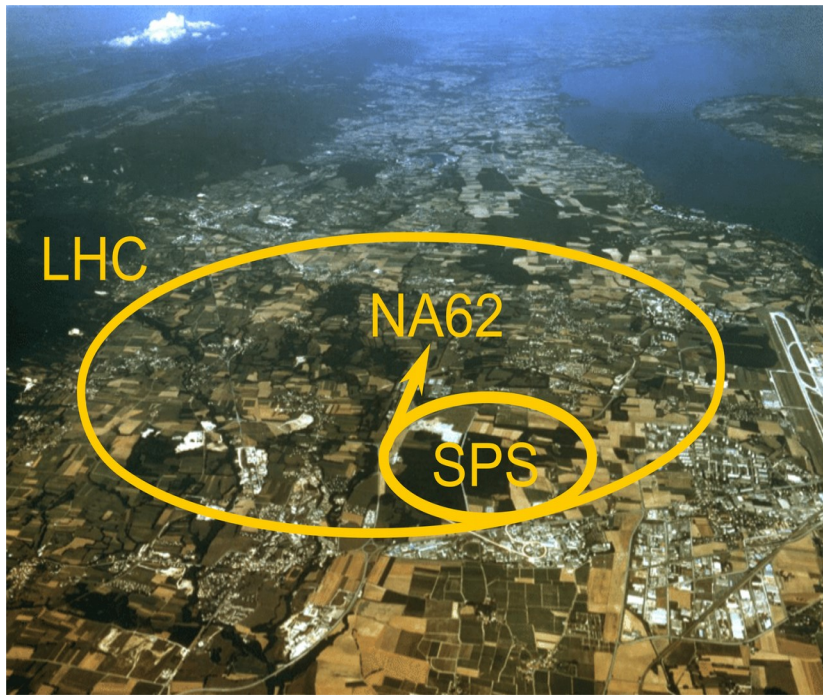


Ghent 2019, 11th July

Outline

- The NA62 Experiment
- The GigaTracKer
- Performances
 - Kinematics
 - Time-stamping resolution

The NA62 experiment



NA62 – fixed target kaon experiment at the CERN SPS

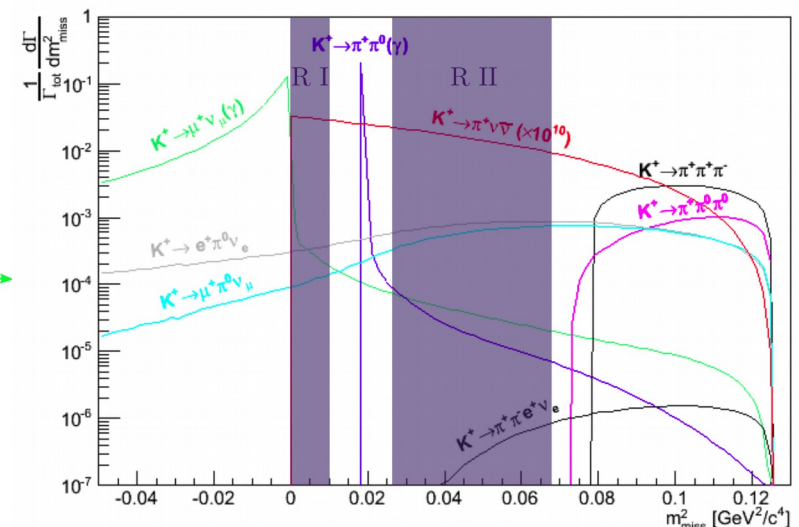
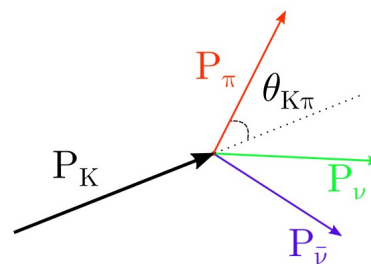
Main goal: measurement of the $\text{BR}(K^+ \rightarrow \pi^+ \nu \bar{\nu})$ with 10% precision using novel **kaon-in-flight** technique.

SM prediction: $\mathcal{B}(K^+ \rightarrow \pi^+ \nu \bar{\nu}) = (8.4 \pm 1.0) \times 10^{-11}$

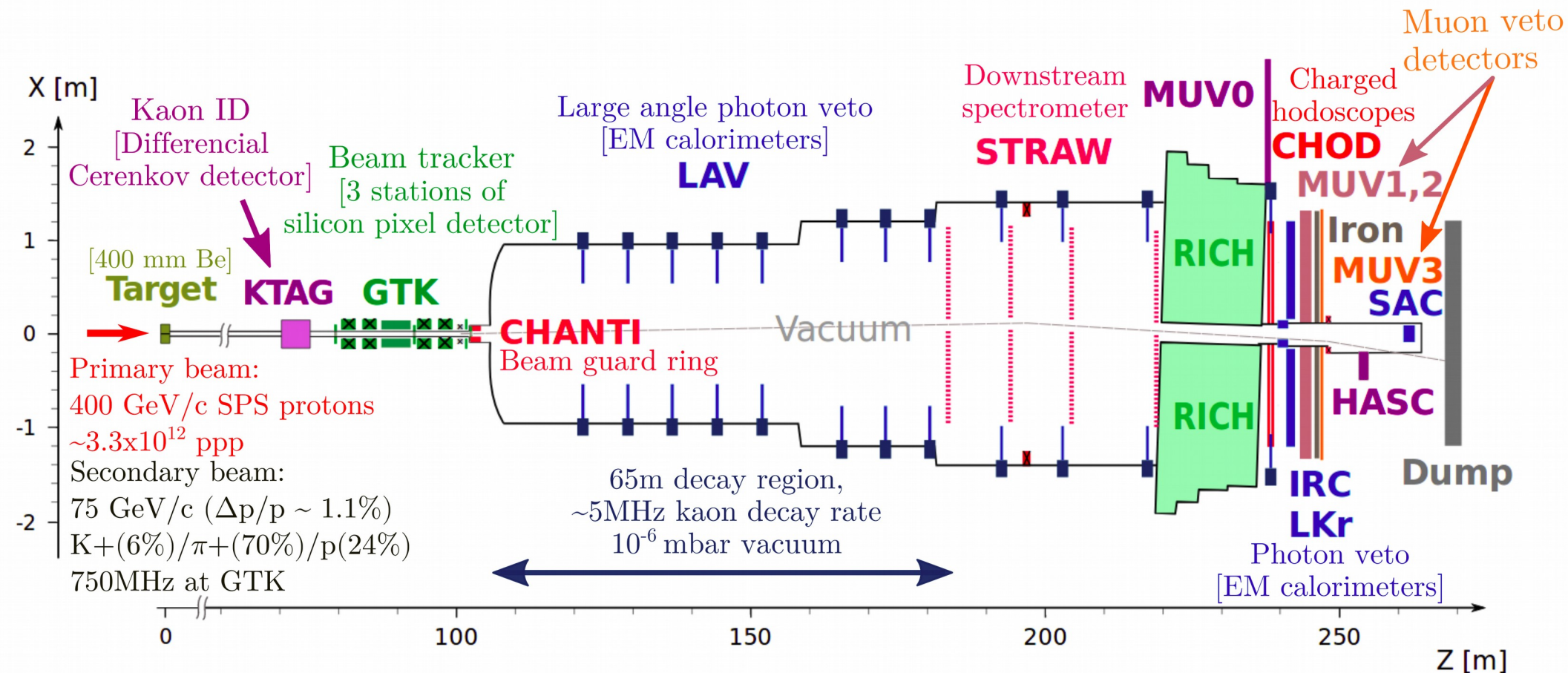
Most discriminating variable: $m_{\text{miss}}^2 = (P_{K^+} - P_{\pi^+})^2$ requires precise measurements of kaon and pion momentum

~30 institutes, ~200 participants from:

Birmingham, Bratislava, Bristol, Bucharest, CERN, Dubna, GMU-Fairfax, Ferrara, Firenze, Frascati, Glasgow, Lancaster, Liverpool, Louvain, Mainz, Moscow, Napoli, Perugia, Pisa, Prague, Protvino, Roma I, Roma II, San Luis Potosi, Sofia, Torino, TRIUMF, Vancouver UBC



Detector overview



[NA62 Detector Paper, JINST 12 (2017), P05025]

The GigaTracker

Nominal specifications:

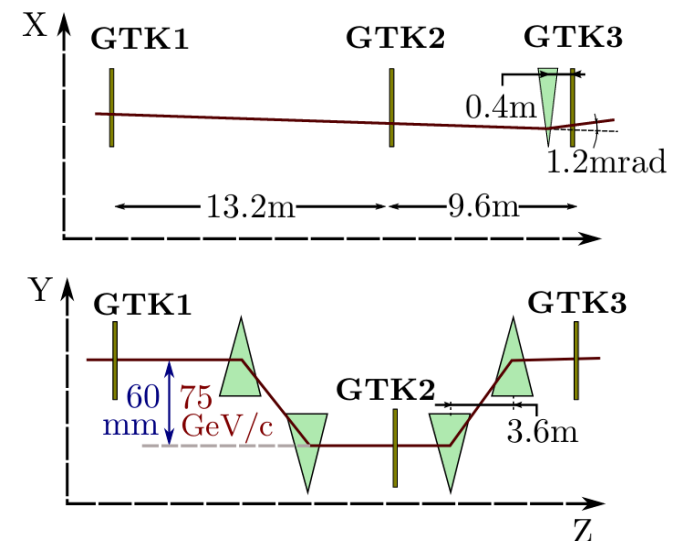
Beam rate	750MHz-1GHz
Peak particle flux	2.0 MHz/mm ²
Peak radiation	4.5×10^{14} 1MeV $n_{eq}/\text{cm}^2/200$ days
Efficiency	99%
Momentum resolution	0.2%
Angular resolution	16 μ rad
Pixel time resolution	200ps RMS
Material budget	0.5% X_0

Beam spectrometer

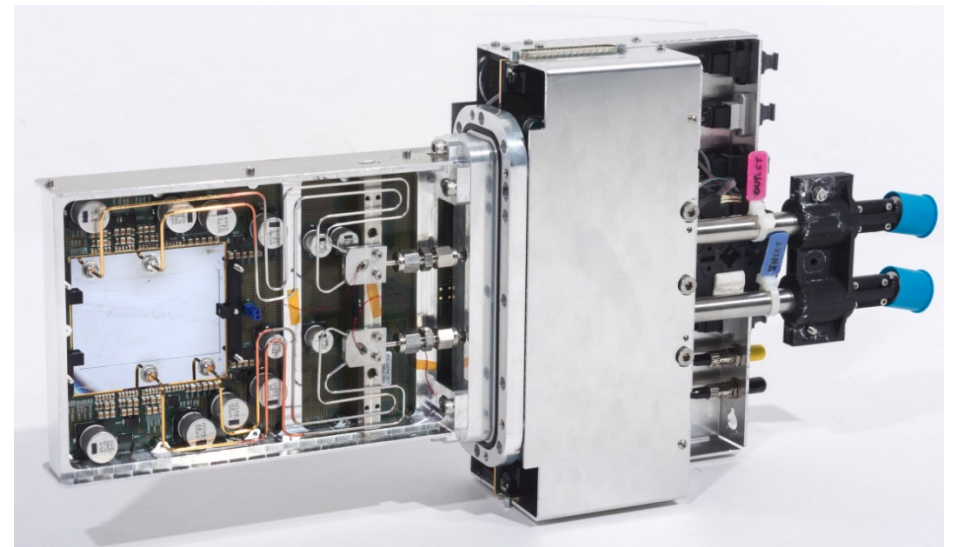
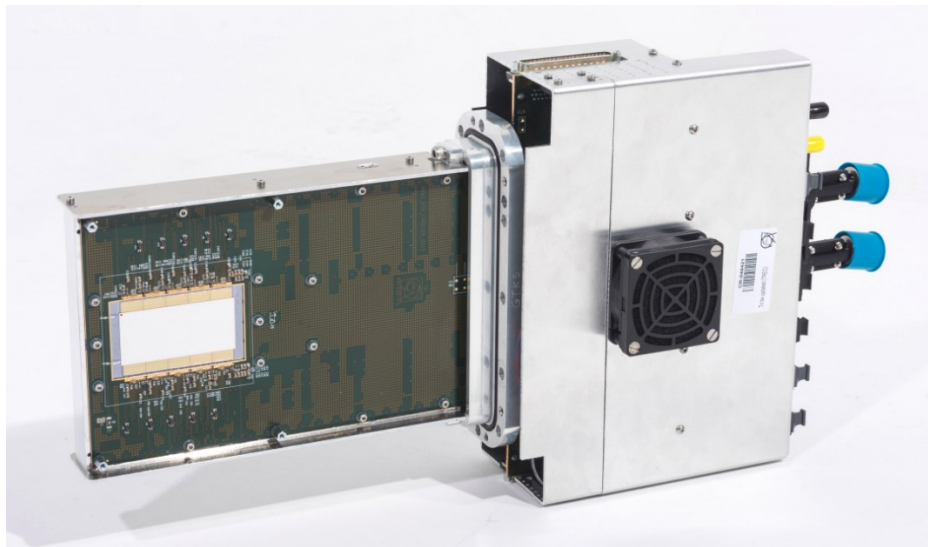
- Measures momentum, angle and time-stamp of all beam tracks
- Sustains high particle flux
- Minimized material budget

Design

- Three planes of Si hybrid pixels
- Installed in beam pipe vacuum: $\sim 10^{-6}$ mbar
- Replaced after 1 year at full intensity



The GigaTracKer

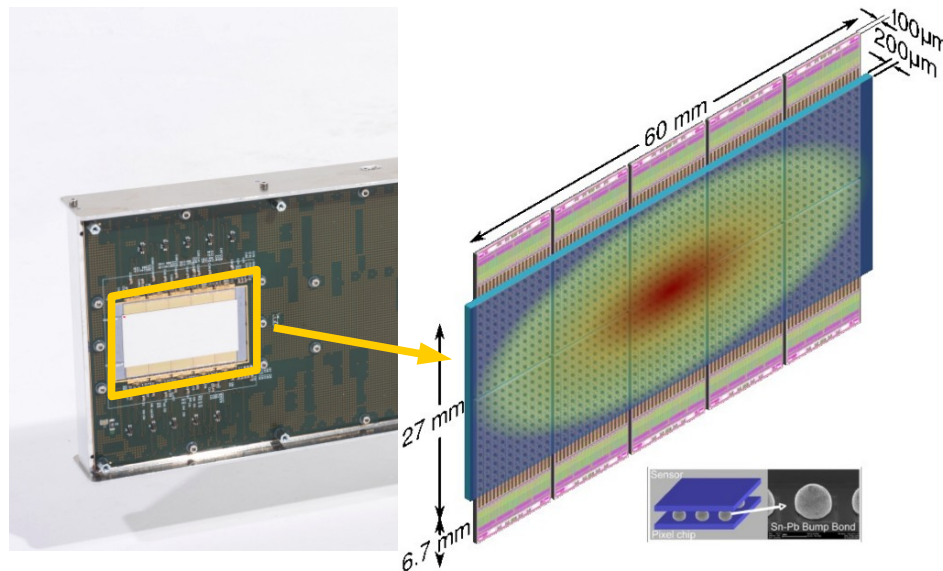


Detailed description can be found [arXiv:1904.12837](https://arxiv.org/abs/1904.12837)

The pixel matrix

TDCPix

Sensor



Sensor:

- n-in-p and p-in-n
- $27 \times 60 \text{ mm}^2$
- $200 \mu\text{m}$ thick ($0.2\% X_0$)
- Bump bonded to 10 chips

Bump-Bonding:

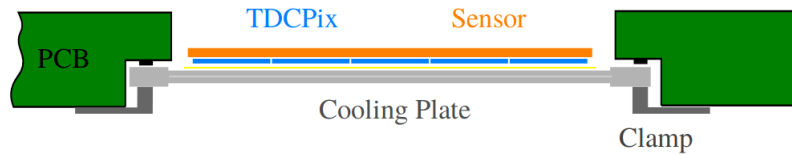
- Sn-Ag bumps
- Benzocyclobutane deposited to avoid discharges

TDCPix:

- IBM 130nm CMOS technology
- $100 \mu\text{m}$ thick ($0.1\% X_0$)
- 1800 pixels of $300 \times 300 \mu\text{m}^2$
- Time resolution: $< 200\text{ps}$
- Peaking time: 5ns
- TDC bin size: 97ps
- SEU mitigation

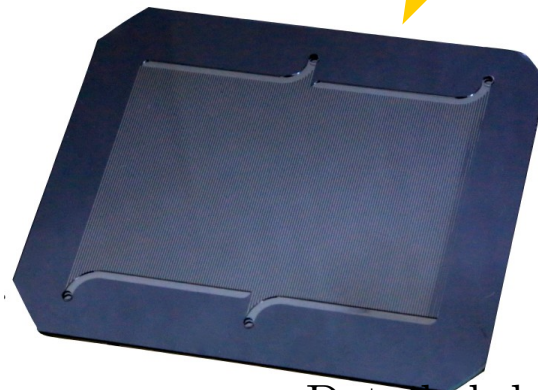
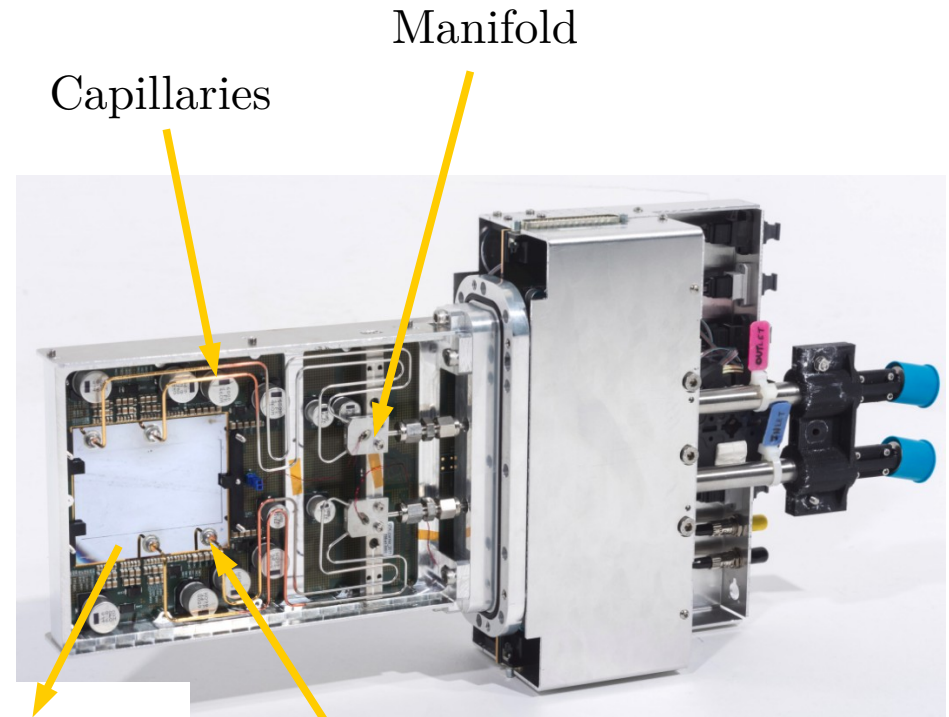
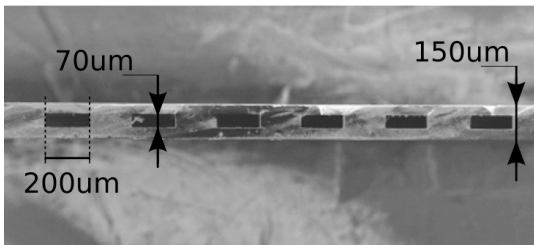
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Cooling plates



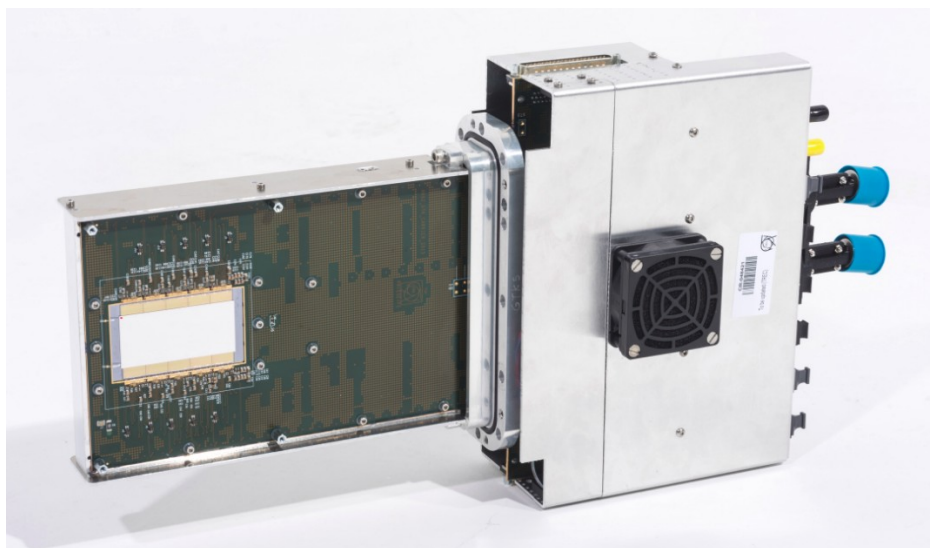
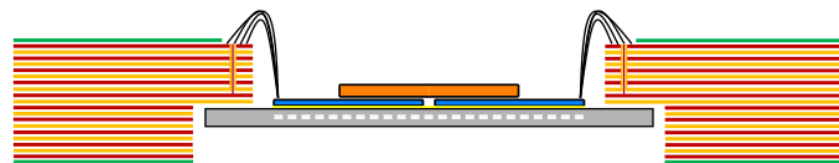
Cooling plate:

- Micro-channel technology – first application in HEP
- Fabricated by CEA Leti
- 210 μm thick (0.2% X_0)
- 70x80 mm^2
- Liquid coolant C_6F_{14}
- Front-end electronics and sensor at $<5^\circ\text{C}$



Detailed description can be found [arXiv:1904.12837](https://arxiv.org/abs/1904.12837)

Electrical Integration



PCB:

- Chips, sensor and cooling plate assembly hosted in the countersink of the carrier board
- 14 layers T-shaped PCB
- 40 differential 3.2 Gb/s signals over 30cm

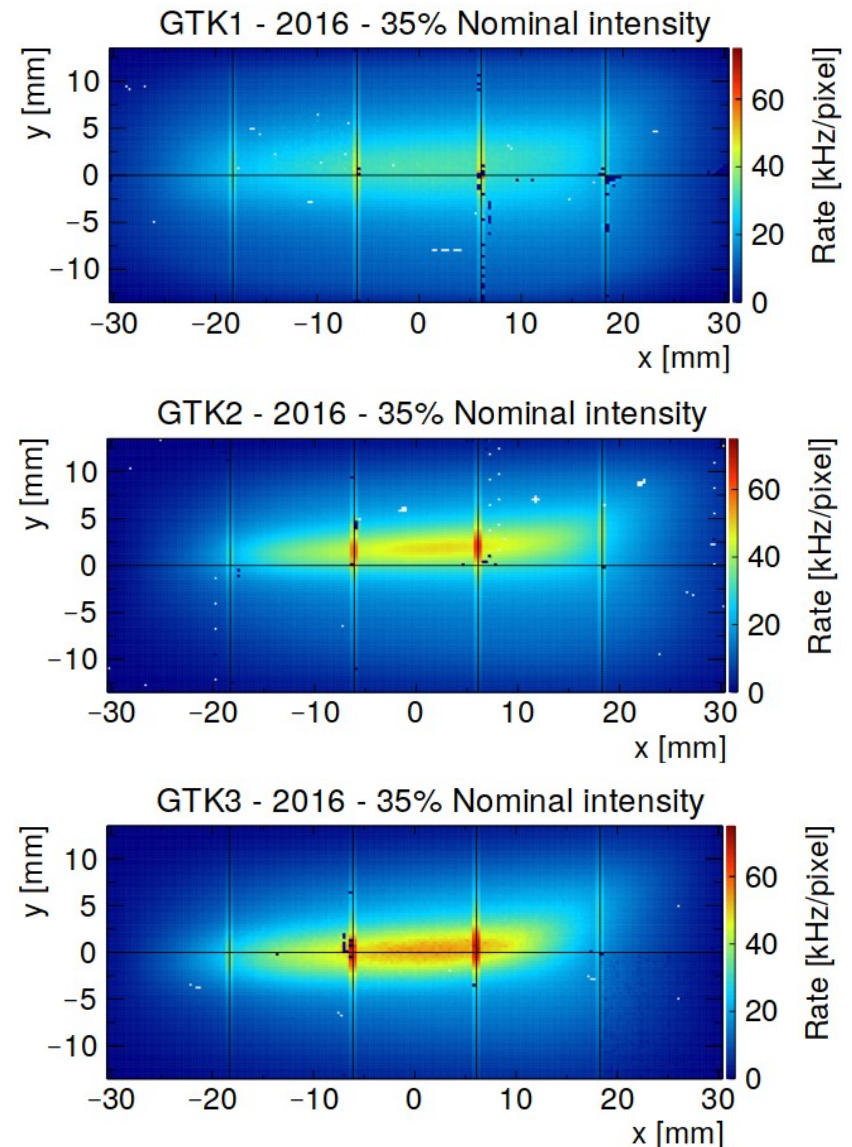
Wire bonding:

- TDCPix wired bonded to PCB
- Dense bonding scheme with 73 μm pitch on TDCPix (1450 bonding pads in PCB)
- Power, Clock, Config, Data transmitted

Detailed description can be found [arXiv:1904.12837](https://arxiv.org/abs/1904.12837)

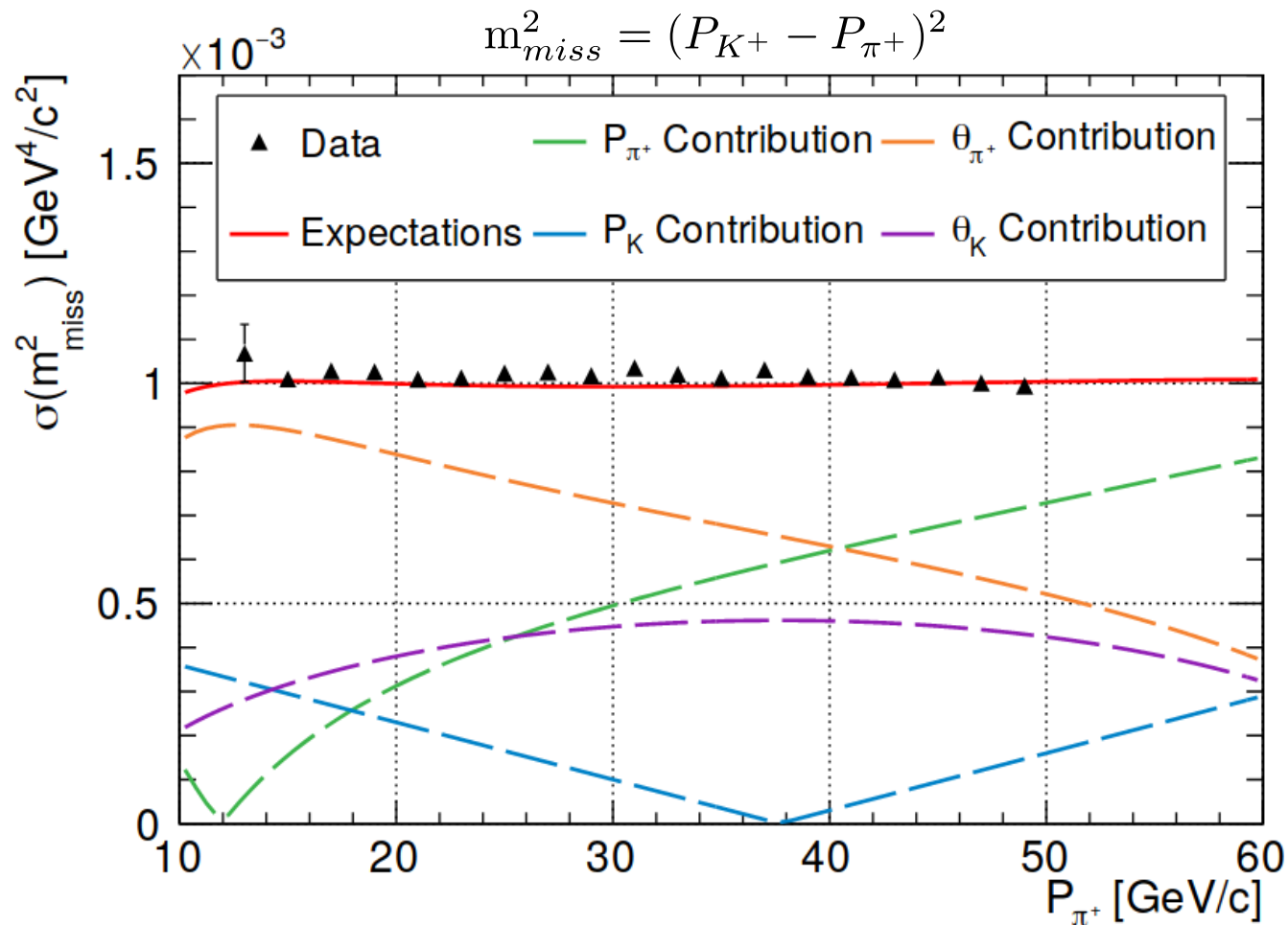
Performances

- Fully operational since September 2016 (first station installed in 2014)
- Few noisy/dead pixels (< 100 per station) at the end of 2017
- Beam intensity in 2016 around 35% of nominal. In 2017 the intensity reached 65% of nominal.



Kinematics

Physics performance from a sample of $K^+ \rightarrow \pi^+ \pi^0$
matches design performance



Time Resolution at Sensor bias of 100 V

Conditions

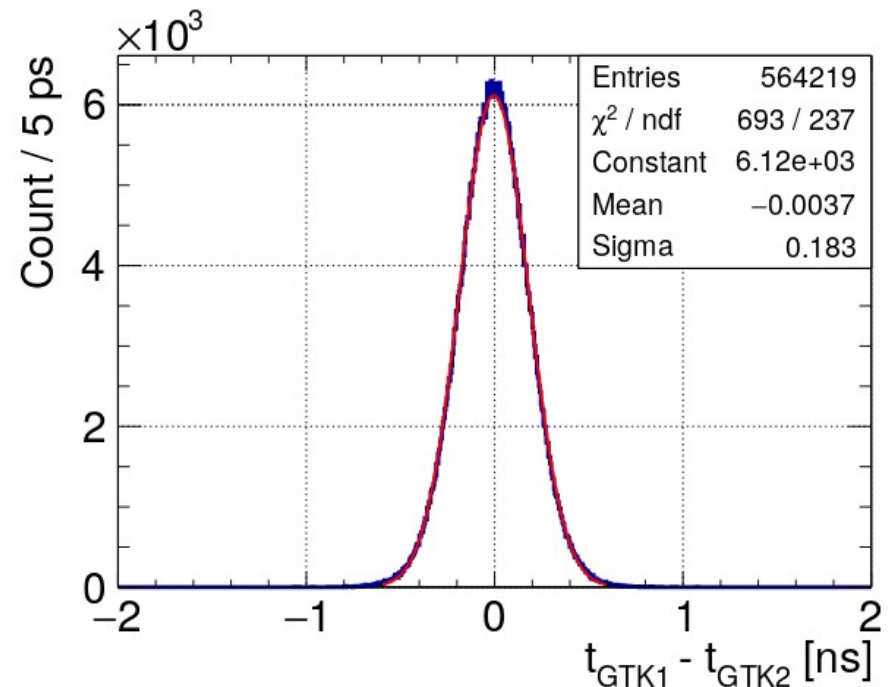
- At detector installation in 2016
- Sensor Type: n-in-p
- Operation bias: 100 V

Two Measurement Methods

- Time difference between GTKs
KTAG RICH ($\sigma_t < 100$ ps)
- Time difference between the 3
GTK stations

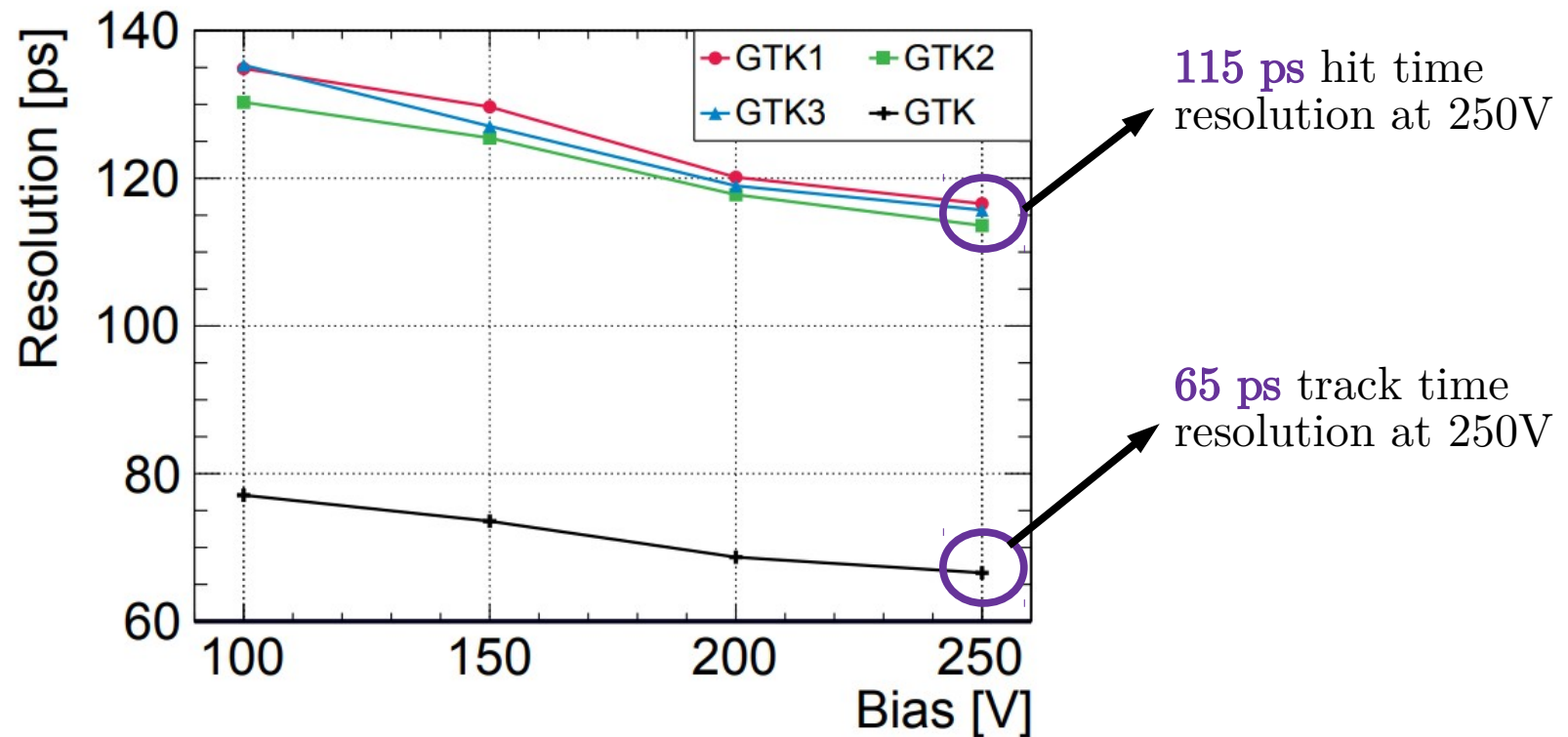
Results

- Hit time resolution: 130 ps
- Track time resolution: 75 ps
- Design resolution matched



GTK1	132.0 ps
GTK2	127.1 ps
GTK3	129.2 ps

Time resolution vs bias voltage



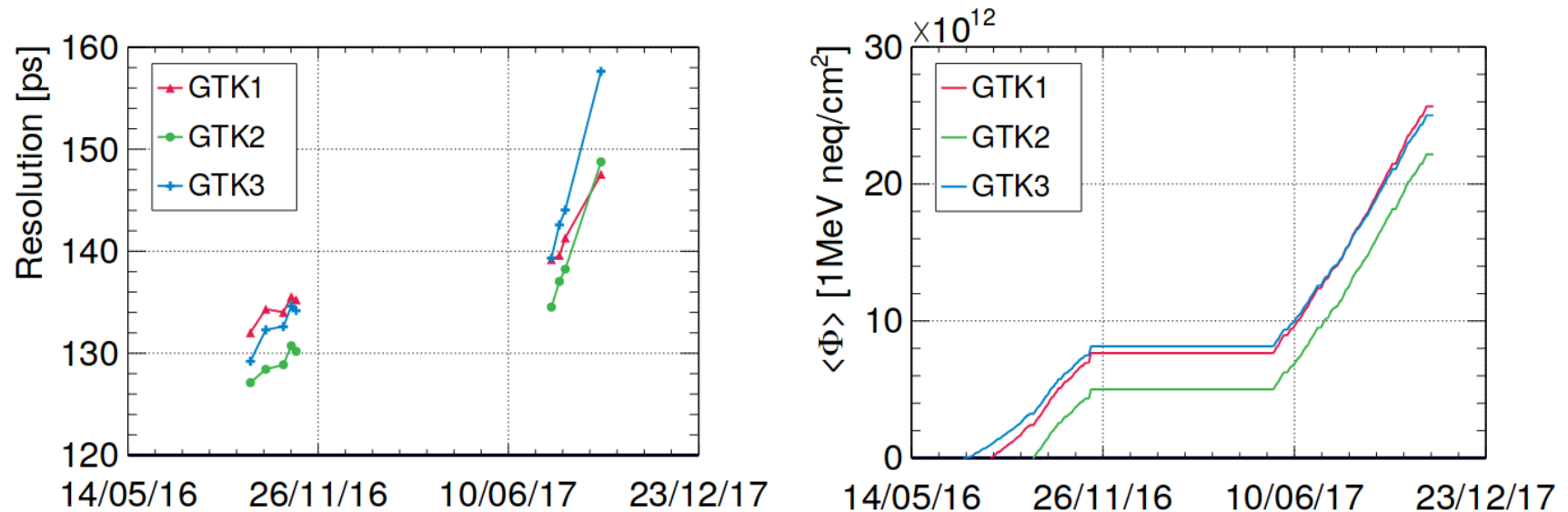
Conditions

- Data collected at end of 2016 run, with n-in-p sensor

Results

- Weak improvement (15%) of the time resolution from 100 V to 250 V
- Charges collected faster but TDCPix pre-amplifier peaking time is fixed (5 ns) and larger than collection time

Time resolution stability over 2016 and 2017



- Degradation of time resolution of up to 25 ps (20%)
- Performances still better than design ones
- Origin not fully understood as many events occurred over 1.5 year
- Radiation is certainly a degradation factor

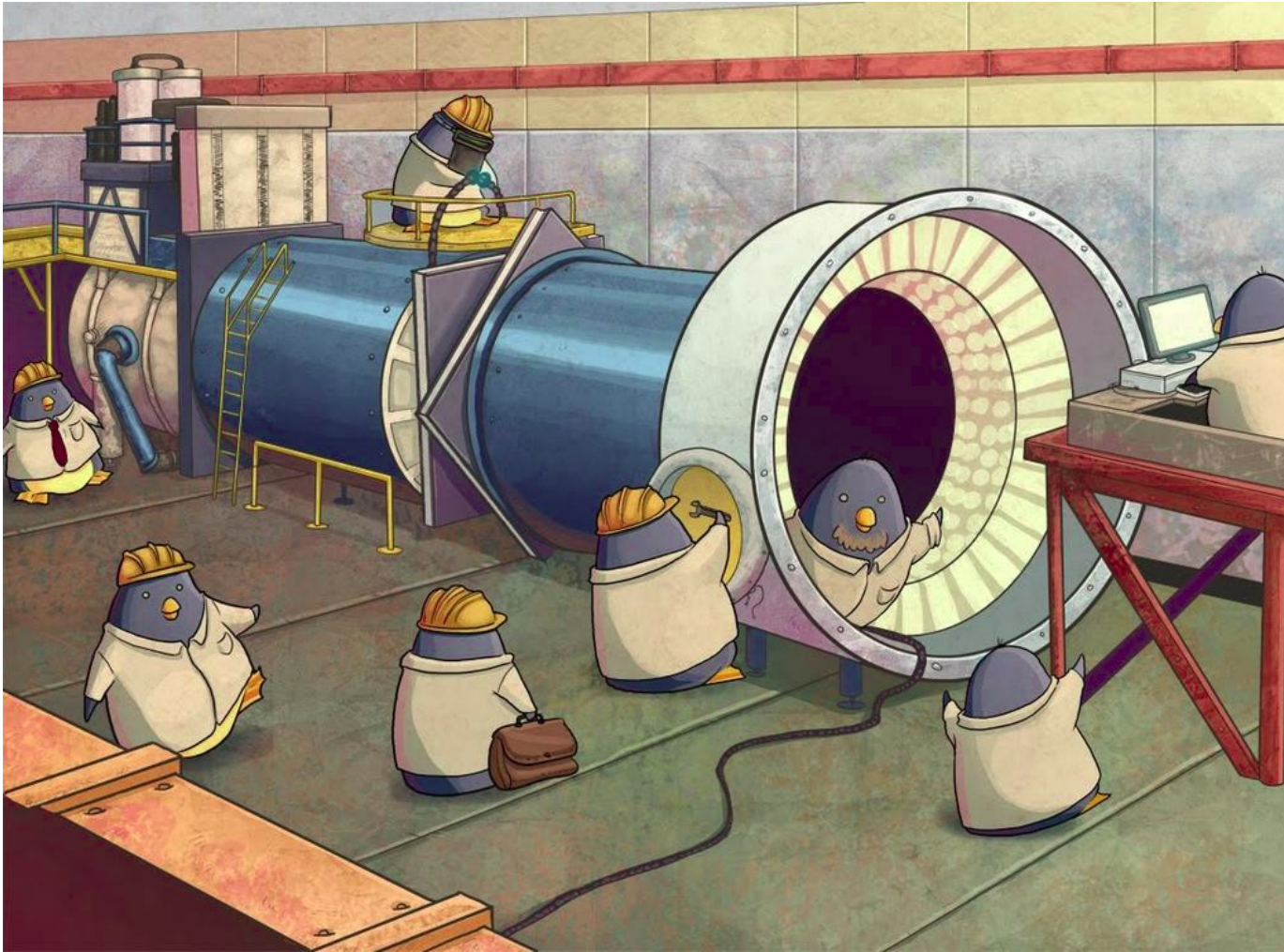
Summary

- The GigaTracKer is the NA62 **4D beam tracker** and is **essential** for the precise measurement of $\text{BR}(\text{K}^+ \rightarrow \pi^+ \nu \bar{\nu})$
- The detector is fully operational since 2016 and successfully took data until the end of Run 2
- The single hit time stamp resolution of **115 ps** was achieved, **surpassing** the design resolution
- Innovative **low mass cooling plate** with silicon micro-channel was implemented (first implementation in HEP)

Prospects:

- Analysis of data collected in 2018 is ongoing
- NA62 will run after LS2

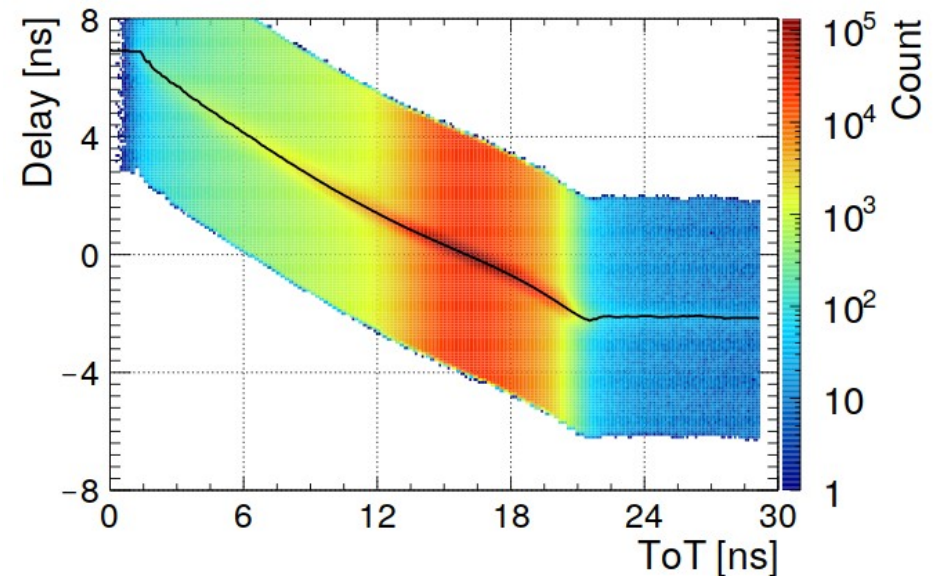
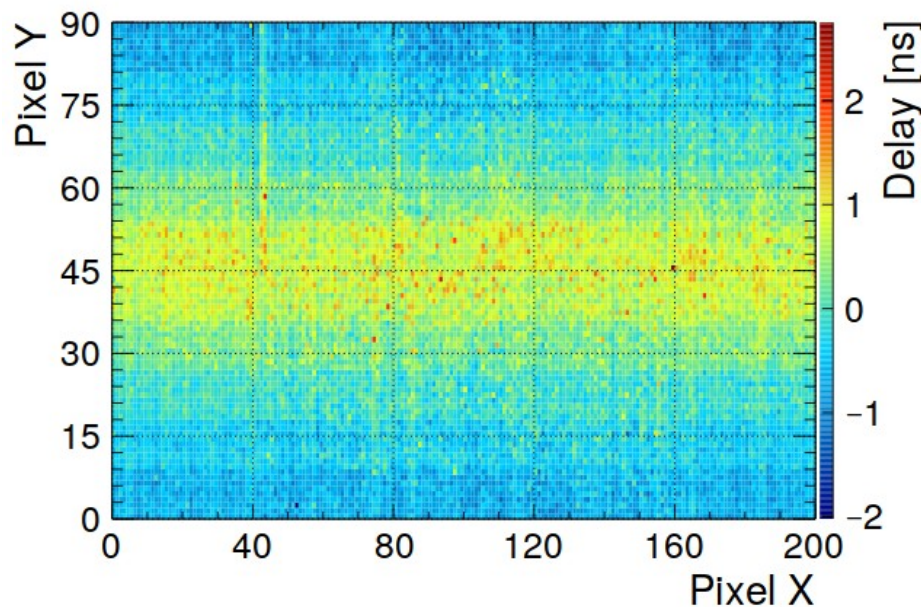
Thank you for your attention!



[Backup]

Time calibration

- Individual pixel delay (54k)
- Chip time walk (1 delay per ToT bin)
- Reference time: KTAG (70 ps resolution)



Efficiency

- GTK efficiency: 97%, which corresponds to 99% station efficiency
- Measured with $K^+ \rightarrow \pi^+ \pi^+ \pi^-$ sample during 8 hours of data taking in October 2017

